

2012 THERMOELECTRICS APPLICATIONS WORKSHOP

High Reliability, High Temperature Thermoelectric Power Generation Materials and Technologies

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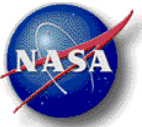
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Baltimore, Maryland
March 21, 2012

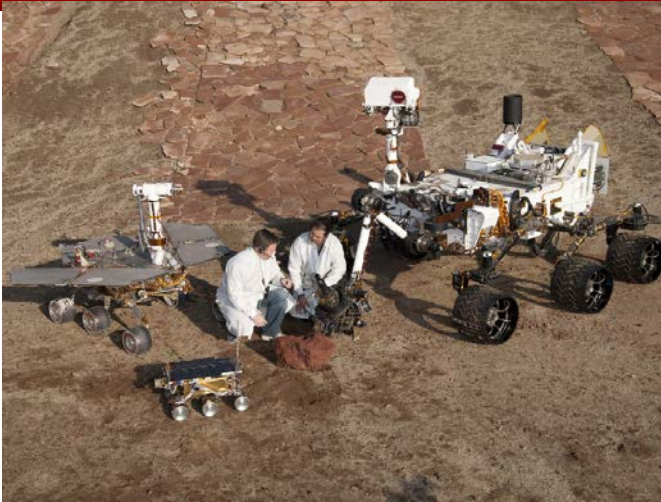




MMRTG-powered Mars Science Laboratory mission



Mars Science Laboratory

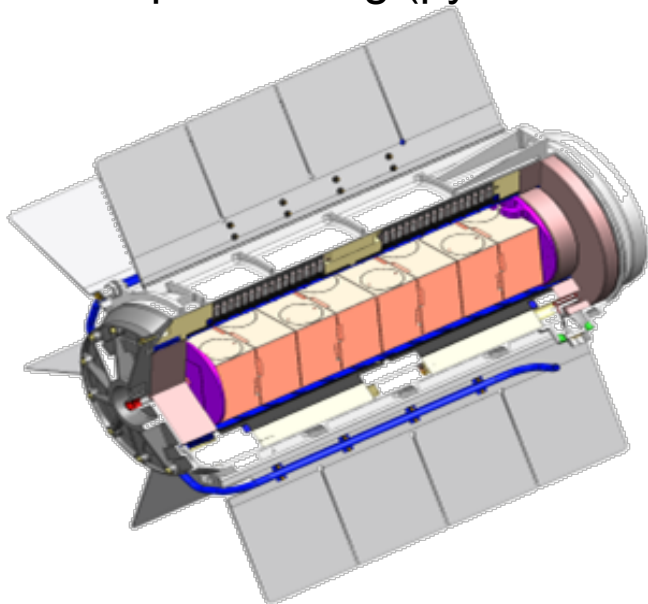


Launch - Nov. 26, 2011
Landing – Early Aug. 2012



Mars Science Laboratory is part of NASA's Mars Exploration Program, a long-term effort of robotic exploration of the red planet. Mars Science Laboratory is a rover that will assess whether Mars ever was, or is still today, an environment able to support microbial life. In other words, its mission is to determine the planet's "habitability."

- **Ability to operate in vacuum and planetary atmospheres**
 - 23-36 V DC capability, series-parallel circuitry
- **17 years lifetime requirement**
 - Up to 3 years of storage and up to 14 years of operation
- **Ability to withstand high mechanical loads**
 - $\sim 0.3 \text{ g}^2/\text{Hz}$ (random vibrations)
 - Up to 6000 g (pyrotechnic shock)



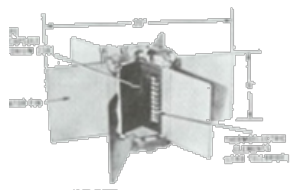
Beginning of Life Performance
 $\sim 125 \text{ W}$
 $\sim 2.8 \text{ W/kg}$



768 <PbTe + TAGS/PbSnTe> couples

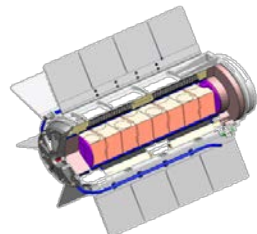
PbTe-based

SNAP-19



40 W_e, 3 W/kg
6.3% Efficiency
Deep space and planetary
surface operation
➤ 30 Year life demonstrated

MMRTG



120 W_e, 2.8 W/kg
6.3% Efficiency
Deep space and
planetary
surface operation

Mission	RTG	TE	Destination	Launch Year	Mission Length
Transit 4A	SNAP-3B7(1)	PbTe	Earth Orbit	1961	15
Transit 4B	SNAP-3B8 (1)	PbTe	Earth Orbit	1962	9
Apollo 12	SNAP-27 RTG (1)	PbTe	Lunar Surface	1969	8
Pioneer 10	SNAP-19 RTG (4)	PbTe/TAGS	Outer Planets	1972	34
Triad-01-1X	SNAP-9A (1)	PbTe	Earth Orbit	1972	15
Pioneer 11	SNAP-19 RTG (4)	PbTe/TAGS	Outer Planets	1973	35
Viking 1	SNAP-19 RTG (2)	PbTe/TAGS	Mars Surface	1975	4
Viking 2	SNAP-19 RTG (2)	PbTe/TAGS	Mars Surface	1975	6
LES 8	MHW-RTG (4)	Si-Ge	Earth Orbit	1976	15
LES 9	MHW-RTG (4)	Si-Ge	Earth Orbit	1976	15
Voyager 1	MHW-RTG (3)	Si-Ge	Outer Planets	1977	31
Voyager 2	MHW-RTG (3)	Si-Ge	Outer Planets	1977	31
Galileo	GPHS-RTG (2) RHU(120)	Si-Ge	Outer Planets	1989	14
Ulysses	GPHS-RTG (1)	Si-Ge	Outer Planets/Sun	1990	18
Cassini	GPHS-RTG (3) RHU(117)	Si-Ge	Outer Planets	1997	11
New Horizons	GPHS-RTG (1)	Si-Ge	Outer Planets	2005	3 (17)
MSL	MMRTG (1)	PbTe/TAGS	Mars Surface	2011	3

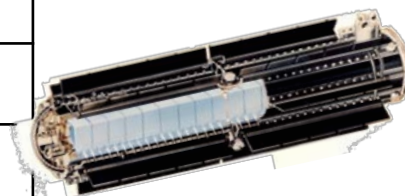
SiGe-based

MHW-RTG



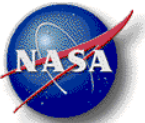
158 W_e, 4.2 W/kg
6.5% Efficiency
Deep space operation
➤ 30 Year life demonstrated

GPHS-RTG



285 W_e, 5.1 W/kg
6.5% Efficiency
Deep space operation
> 18 Year life demonstrated

RTGs have been successfully used on a number of long-life missions



TE Converter Configurations

Couple Configuration	P-leg	N-leg	Heat Source Coupling	Program
Segmented Couple	$\text{Bi}_2\text{Te}_3/\text{TAGS}/\text{PbSnTe}$	$\text{Bi}_2\text{Te}_3/\text{PbTe}$	Conductive	Terrestrial RTGs
Segmented Couple	$\text{TAGS}/\text{PbSnTe}$	PbTe	Conductive	SNAP-19, MMRTG
Segmented Couple	$\text{Si}_{0.63}\text{Ge}_{0.37}/\text{Si}_{0.8}\text{Ge}_{0.2}$	$\text{Si}_{0.63}\text{Ge}_{0.37}/\text{Si}_{0.8}\text{Ge}_{0.2}$	Radiative	MHW-, GPHS-RTG
Multicouple	$\text{Si}_{0.8}\text{Ge}_{0.2}$	$\text{Si}_{0.8}\text{Ge}_{0.2}$	Conductive, Radiative	SP-100, MOD-RTG
Segmented Couple	$\text{Bi}_2\text{Te}_3/\text{SKD}^*$	$\text{Bi}_2\text{Te}_3/\text{SKD}$	Conductive	Segmented TE Couple (2002)
Multicouple	SKD (Skutterudites)	SKD	Conductive	STMC (2005)
Unsegmented Couple	Zintl	Nano $\text{Si}_{0.8}\text{Ge}_{0.2}$	Radiative	ATEC
Unsegmented Couple	Zintl	$\text{La}_{3-x}\text{Te}_4$	Conductive or radiative	
Segmented Couple	SKD/Zintl	SKD/ $\text{La}_{3-x}\text{Te}_4$	Conductive or radiative	
Segmented Couple	Adv. PbTe/Zintl	Adv. $\text{PbTe}/\text{La}_{3-x}\text{Te}_4$	Conductive	
Segmented Multicouple	SKD/Zintl	SKD/ $\text{La}_{3-x}\text{Te}_4$	Conductive or radiative	2012 Small FPS

Terrestrial RTG

MMRTG

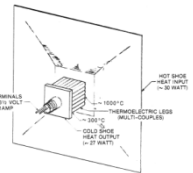
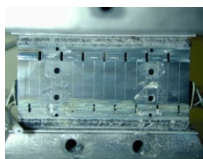
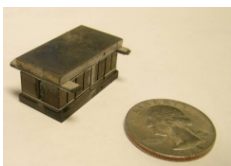
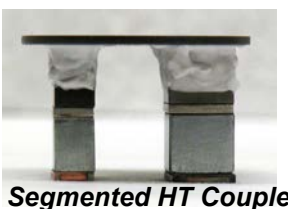
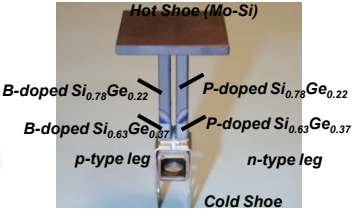
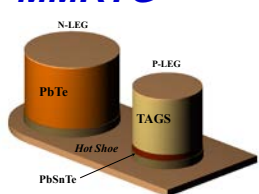
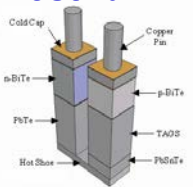
MHW-RTG

ATEC

STMC

SP-100

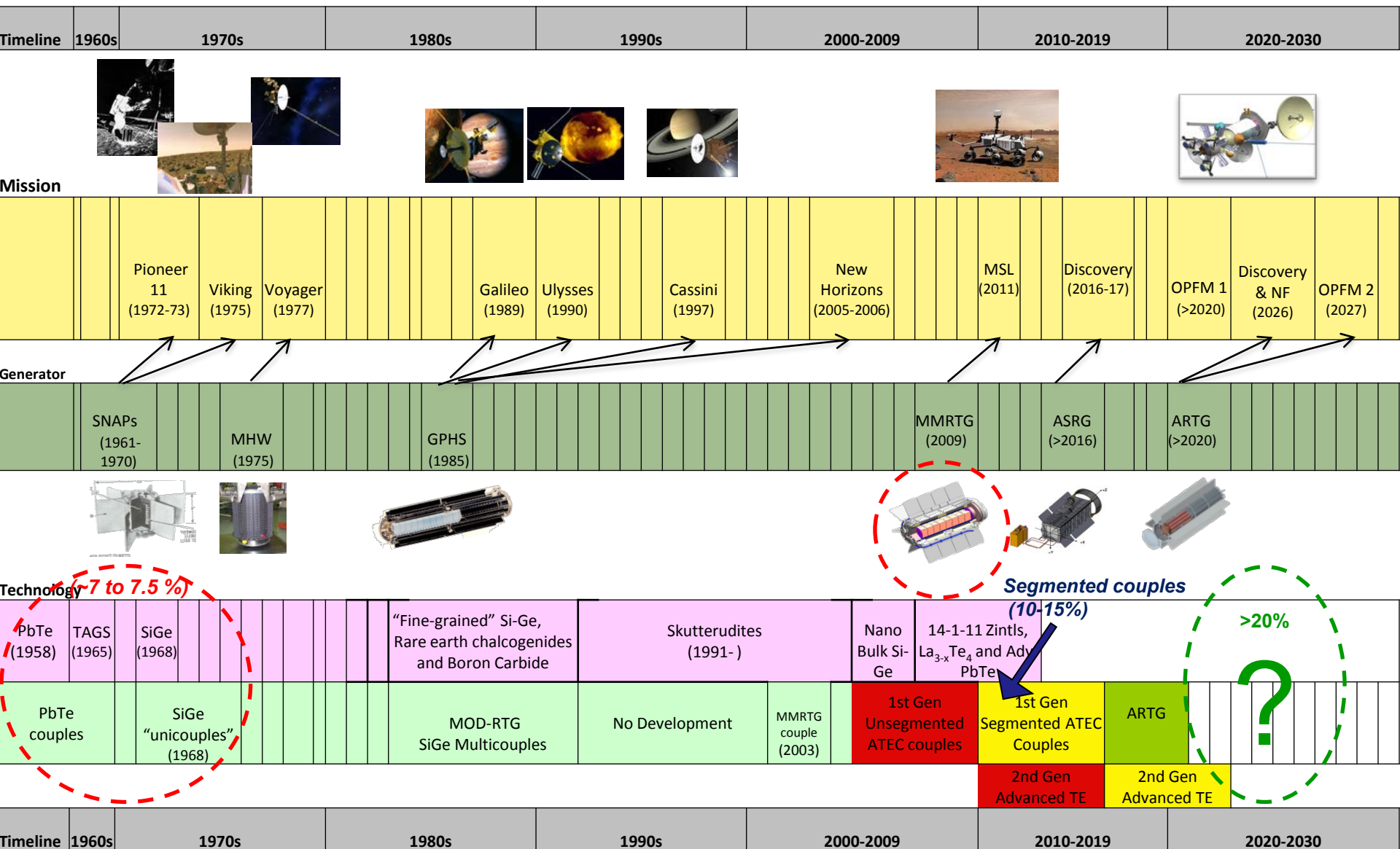
MOD-RTG

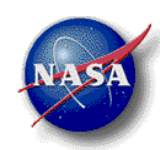


Multicouples developed for higher power systems (space reactor, terrestrial)
Arrays of discrete couples typically used for RTGs

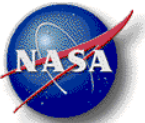


High Temperature TE Materials RTG Technology Development Timeline

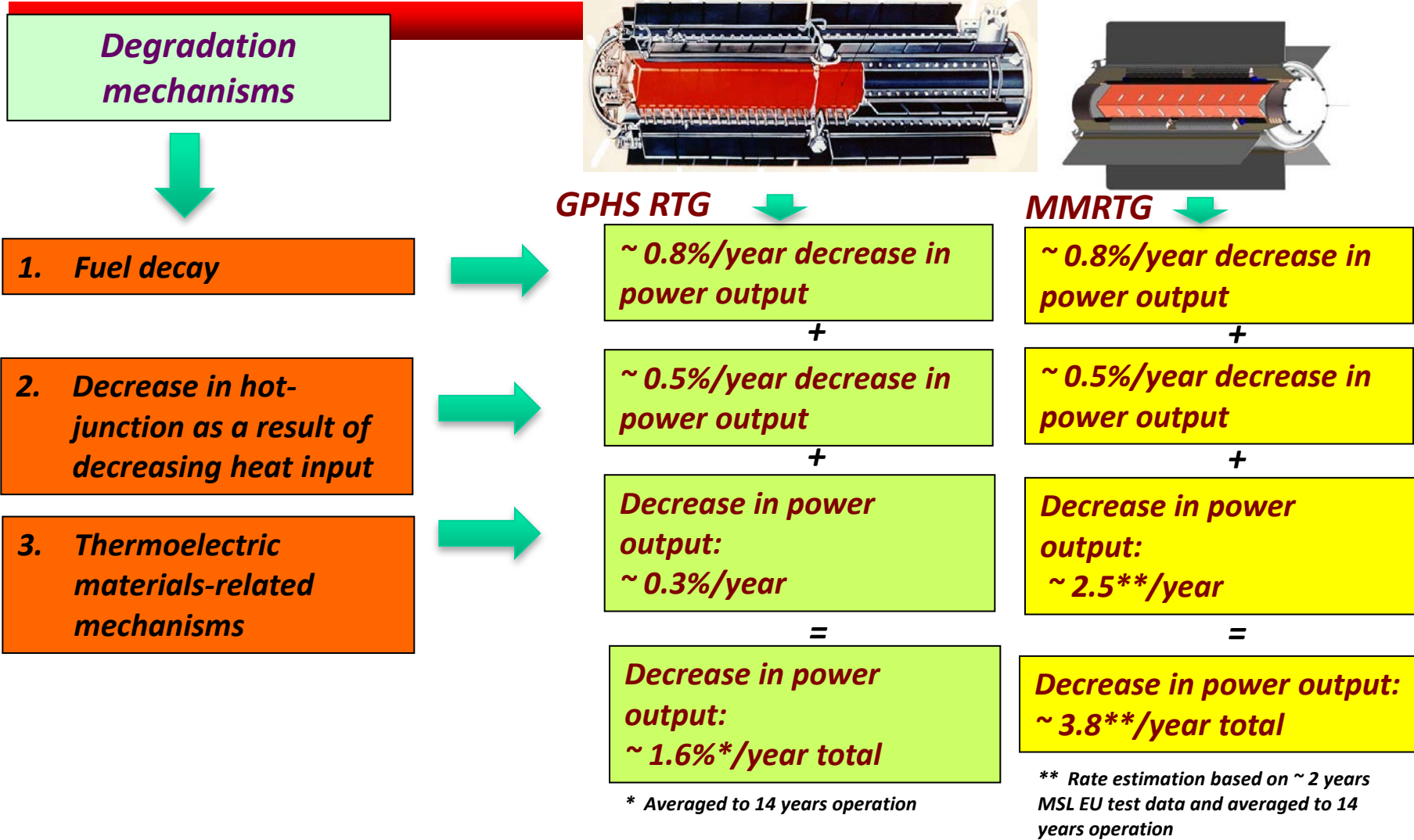




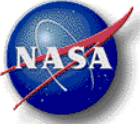
Lifetime Performance Validation



What controls RTGs Lifetime Performance?



TE-related degradation mechanisms can represent a significant fraction of the overall RTG degradation over time

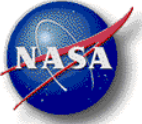


Impact of key TE-related degradation mechanisms on RTG performance



Degradation mechanism	Key potential impact(s)	Impact(s) on RTG performance
Sublimation of TE materials <i>(A major concern for most TE materials...)</i>	<ul style="list-style-type: none">• Increase in electrical resistance• Electrical and thermal shorts• Promote the degradation of couple interfaces at the hot-junctions• Potentially impact all other mechanisms	<ul style="list-style-type: none">• Reduced power• Electrical isolation
Changes in TE properties <i>(can be due to dopant precipitation, structural phase changes, phase segregation, electromigration, etc...)</i>	<ul style="list-style-type: none">• Can reduce thermoelectric efficiency if lower ZT• Lower temperature gradient across TE elements if increased thermal conductivity	<ul style="list-style-type: none">• Reduced power
Increase in electrical & thermal contact resistances at interfaces <i>(can be due to interdiffusion, microcrack propagation, etc...)</i>	<ul style="list-style-type: none">• Increase in electrical resistance• Lower temperature gradient across TE elements	<ul style="list-style-type: none">• Reduced power
Increased conductance of thermal insulation <i>(can be due to interactions between insulation packaging, TE materials and sublimation products, etc...)</i>	<ul style="list-style-type: none">• Increased heat losses• Reduced heat flux through the thermoelectric couples	<ul style="list-style-type: none">• Reduced power• Thermal management

Each TE-related degradation mechanism can have a significant impact on overall RTG degradation over time; must be tested for, quantified and modeled



Life Testing & Performance Validation



- Materials (TRL 1-3)

- Stable TE properties vs. time & temperature demonstrated over > 1 year of testing
- Control of sublimation rates down to 10^{-6} to 10^{-7} g.cm²/hr, verified over > 1 year of testing

- Couples TRL (2-4)

- Stable electrical contact metallizations
- Stable interfaces to hot and cold shoes, between TE segments
- Maintain mechanical, thermal and electrical integrity
- Greater than 5 years life predicted based on normal and accelerated testing

- Couple Arrays (TRL 3-5)

- Use of prototypic couples
- No interaction with thermal insulation, verification of mechanical integrity
- Greater than 3 years of testing

- Electrically heated Power Demonstrator (EPD, 18-couple) (TRL 4-5)

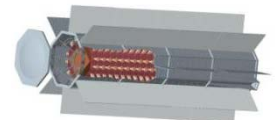
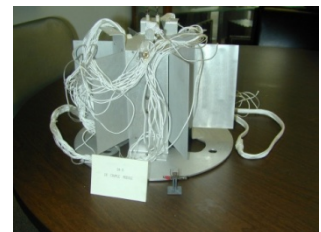
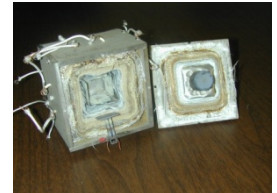
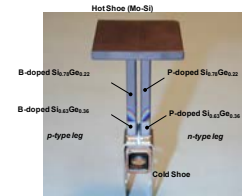
- Demonstration of thermal and electrical efficiencies at subscale system level

- ETG (TRL 6)

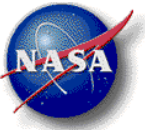
- Validation of thermal and electrical efficiencies at full scale system level
- Qualification testing

- Life Performance Model

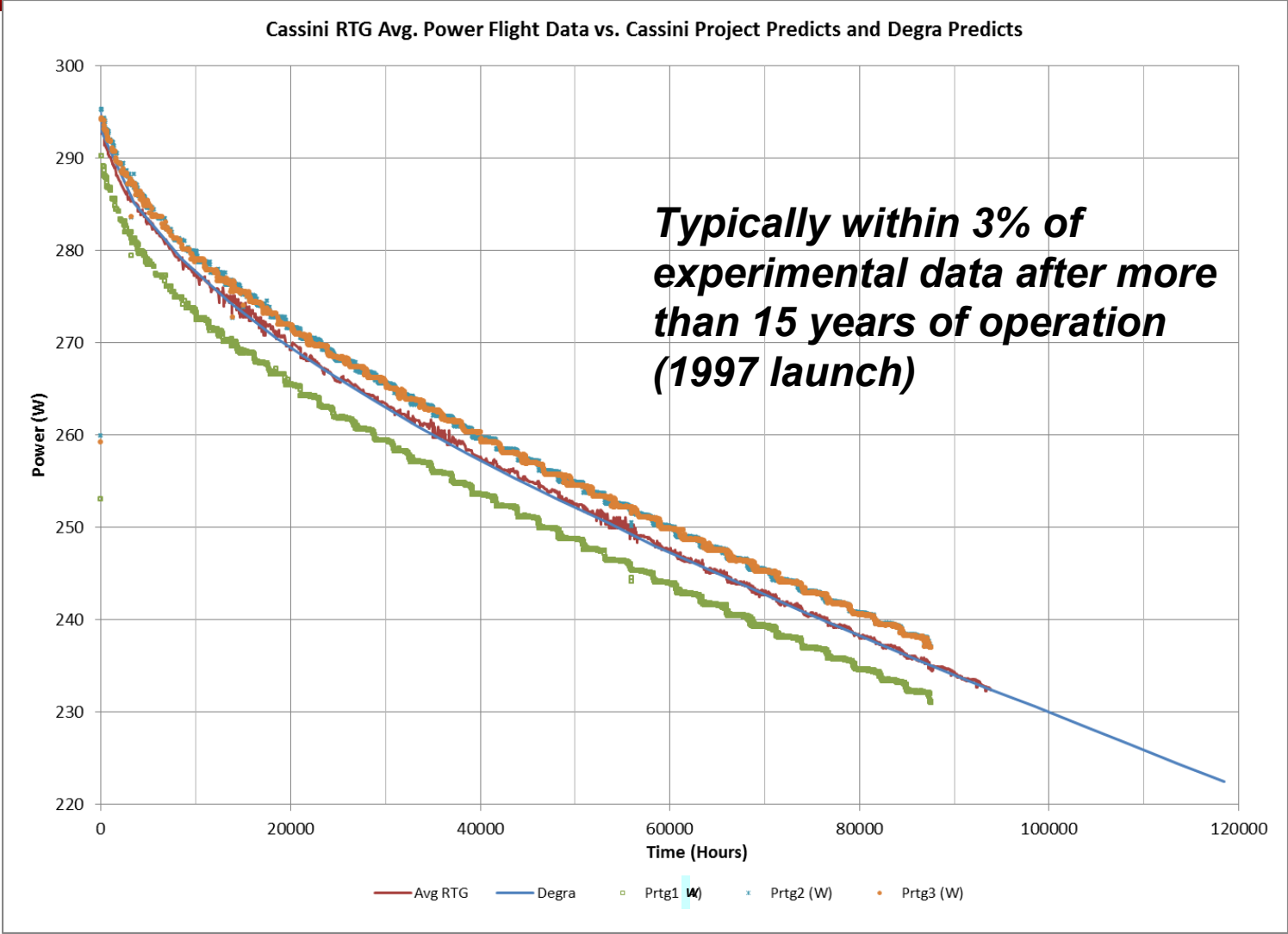
- Materials properties and test data used to predict long term performance
- Provide Mission planners with performance profile during various scenarios and operation phases



***Well defined technology development roadmap
to establish lifetime performance of RTGs***

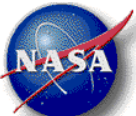


GPHS-RTG Data & Lifetime Performance Predictions

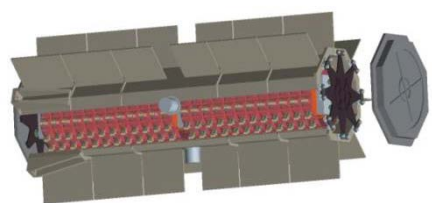




High Temperature TE Couple Technology Development for Next Generation Space Power Systems

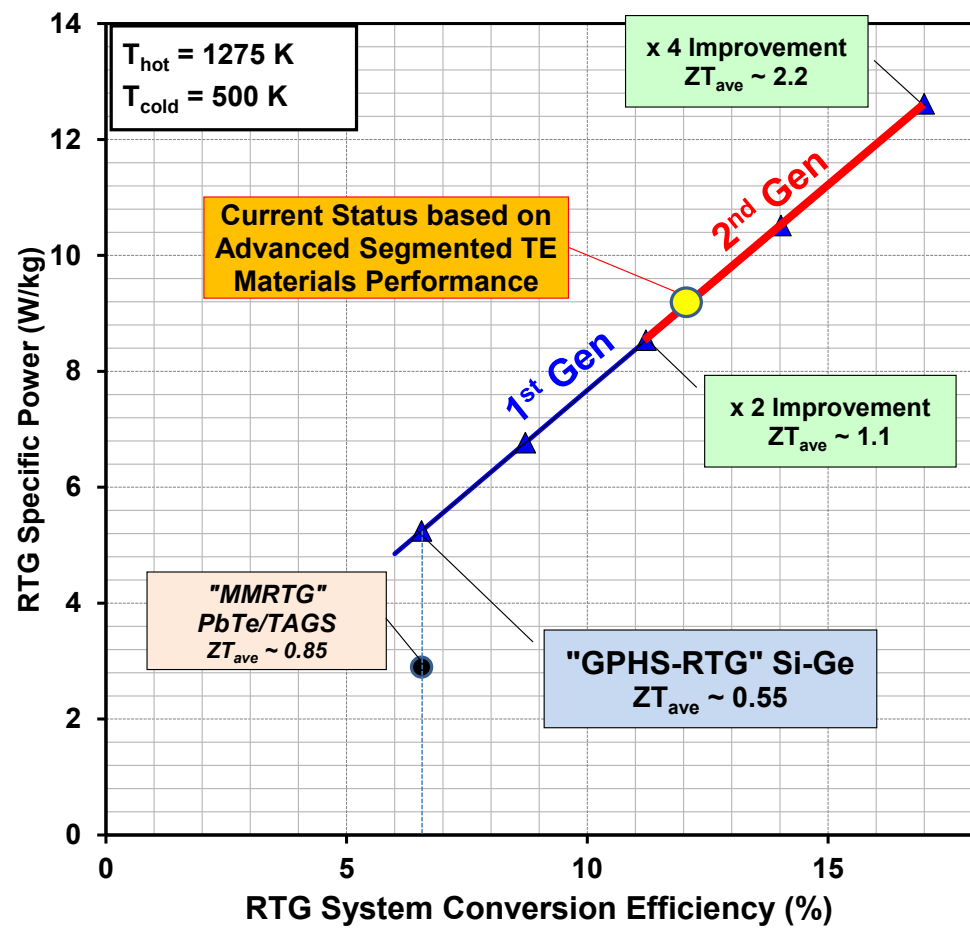


Impact of Higher Performance Materials on Thermoelectric Power Systems for Space Exploration



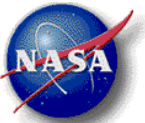
**$T_{hot} = 1100\text{ K}$
to 1275 K**
(higher is better!)

**Lower System
Mass and Higher
Conversion
Efficiency Needed
(x2 to 4)**

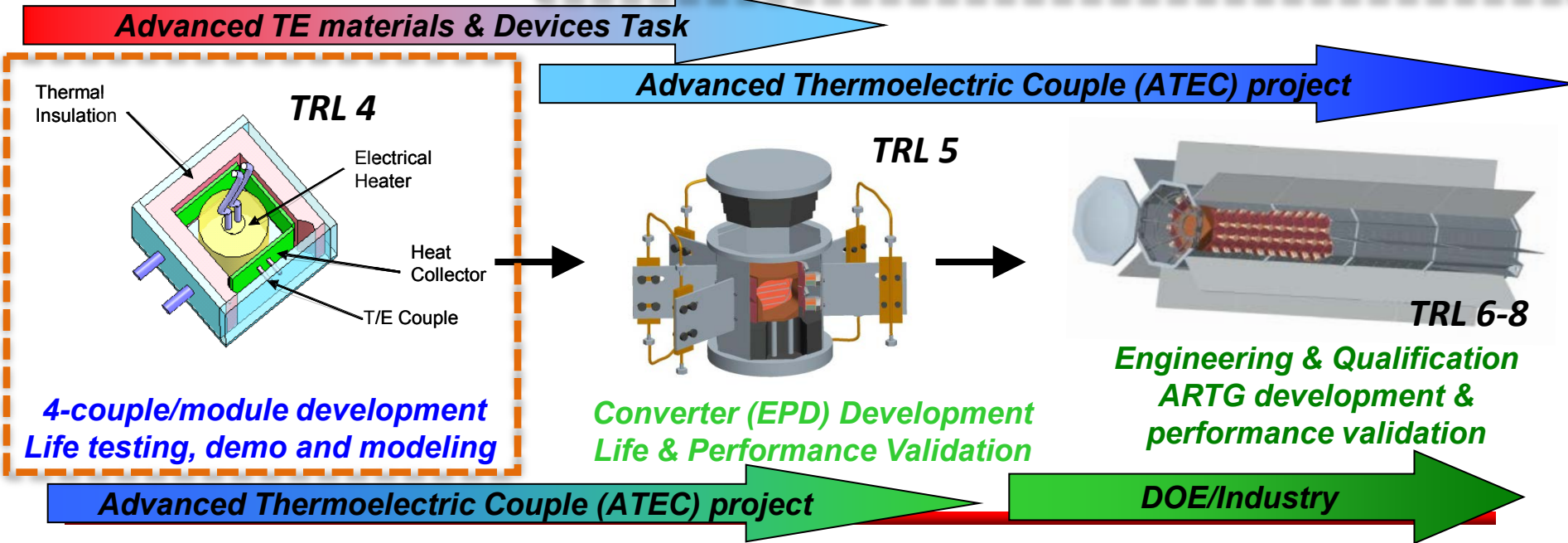
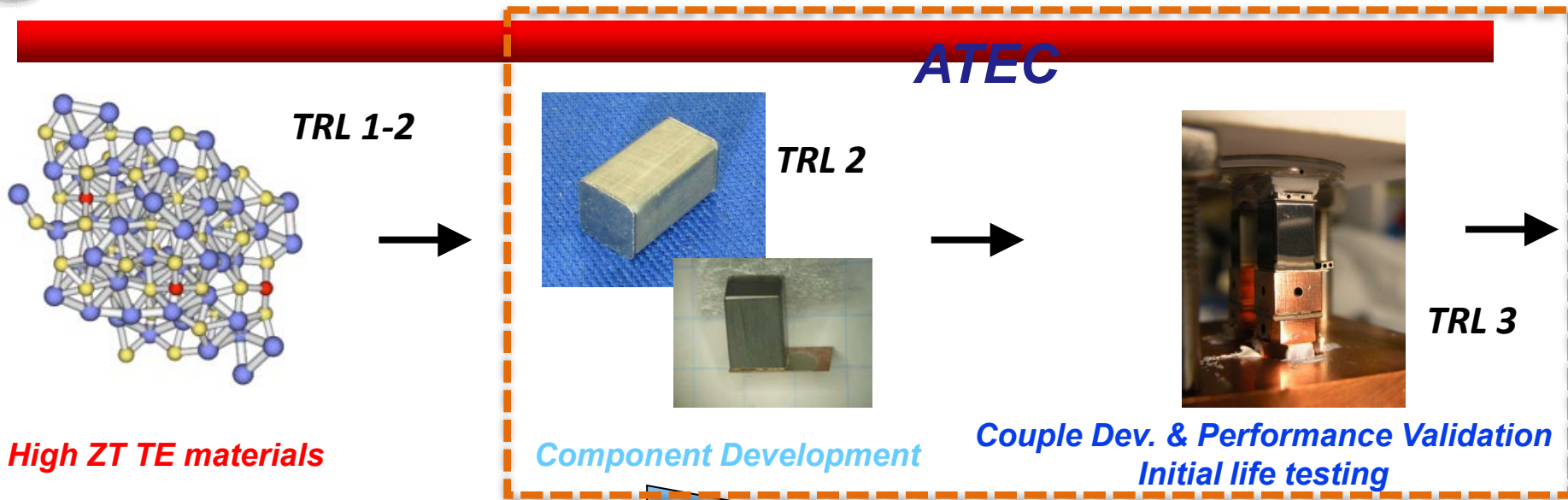


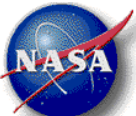
Advanced RTG Specific Power vs. System Conversion Efficiency
(Based on radiatively coupled vacuum operation uncouple based RTG concept)

Ultimate goal: > 15% efficient, >10 W_e/kg Advanced RTGs



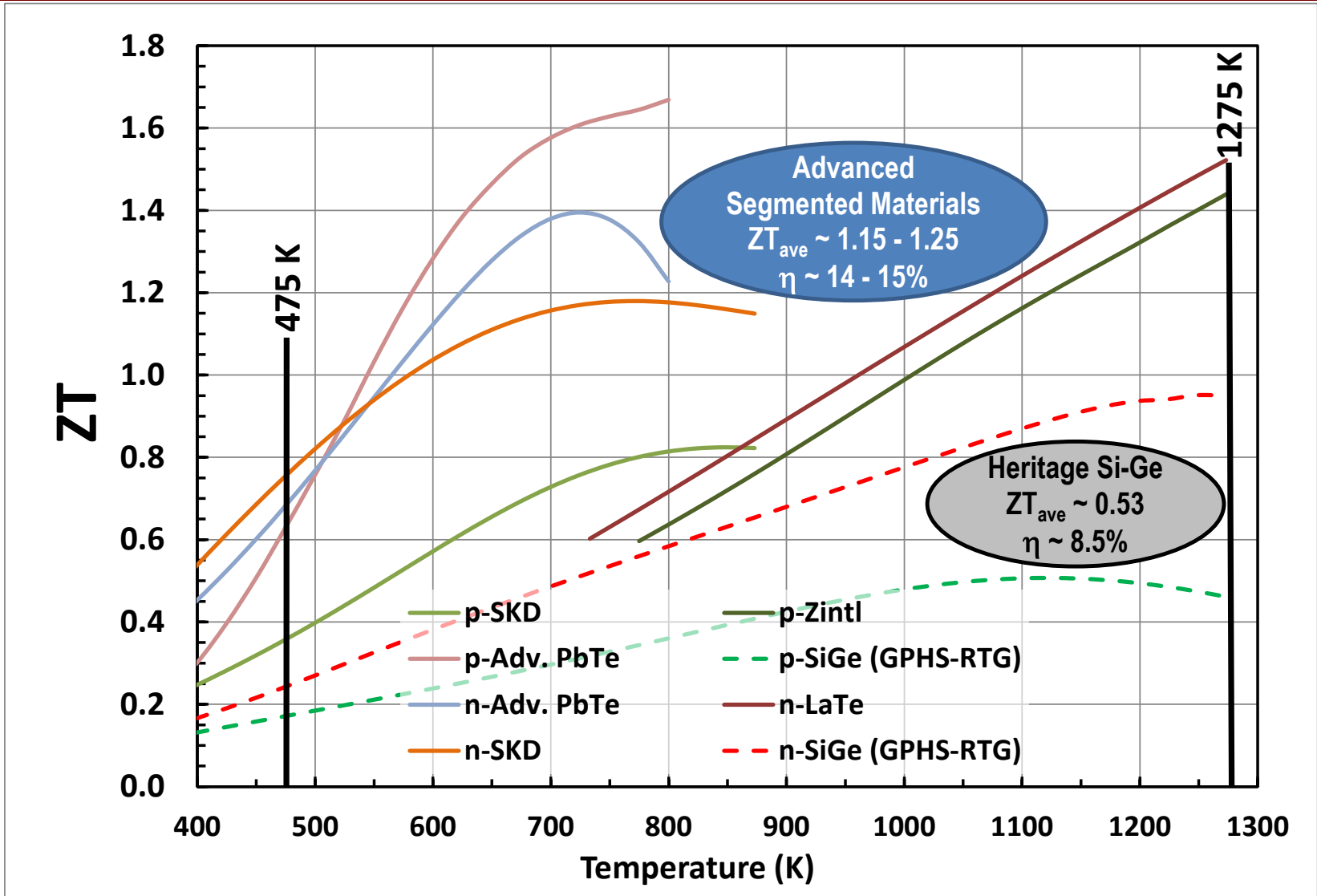
Advanced RTG Technology Development Path

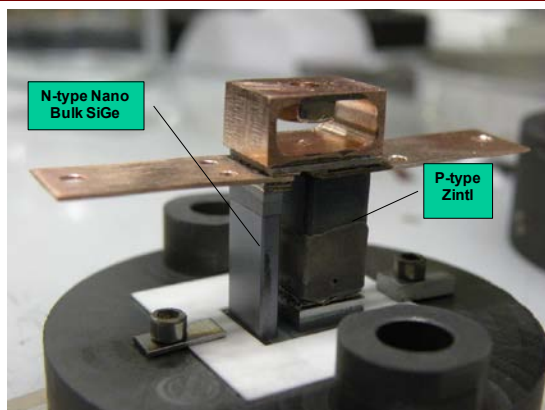




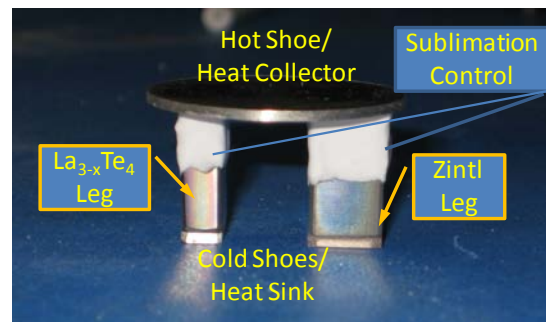
Baseline ATEC advanced TE Materials

Large performance gains over heritage Si-Ge alloys

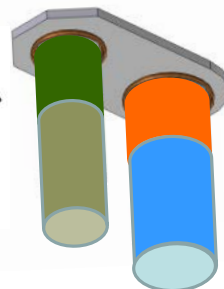
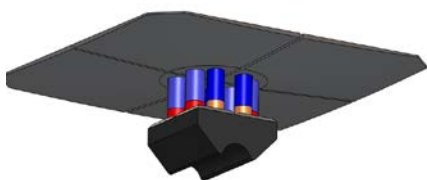
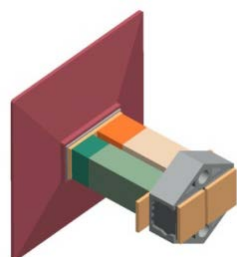
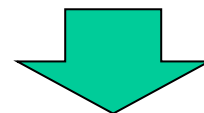




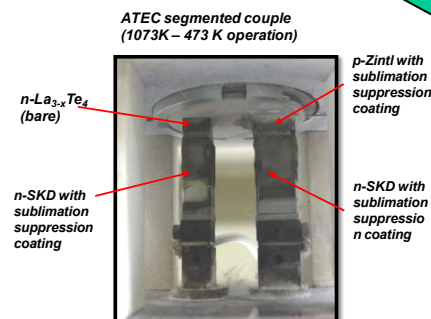
Zintl ($\text{Yb}_{14}\text{MnSb}_{11}$) / NanoSiGe Couple (2007-2009)



Zintl ($\text{Yb}_{14}\text{MnSb}_{11}$) / $\text{La}_{3-x}\text{Te}_4$ Couple (2009-2010)



Zintl // $\text{La}_{3-x}\text{Te}_4$ Cantilevered and Spring-loaded Segmented Couples for Life Performance validation(2012-2014)



Zintl/SKD // $\text{La}_{3-x}\text{Te}_4$ /SKD Segmented Couple (2010-)
Zintl/Adv.PbTe // $\text{La}_{3-x}\text{Te}_4$ /Adv.PbTe Segmented Couple (2012 -)

Materials, Components & Couple Development Challenges

Materials

TE materials

Batch Synthesis Scale-up
Reproducibility and stability of TE Properties

Components

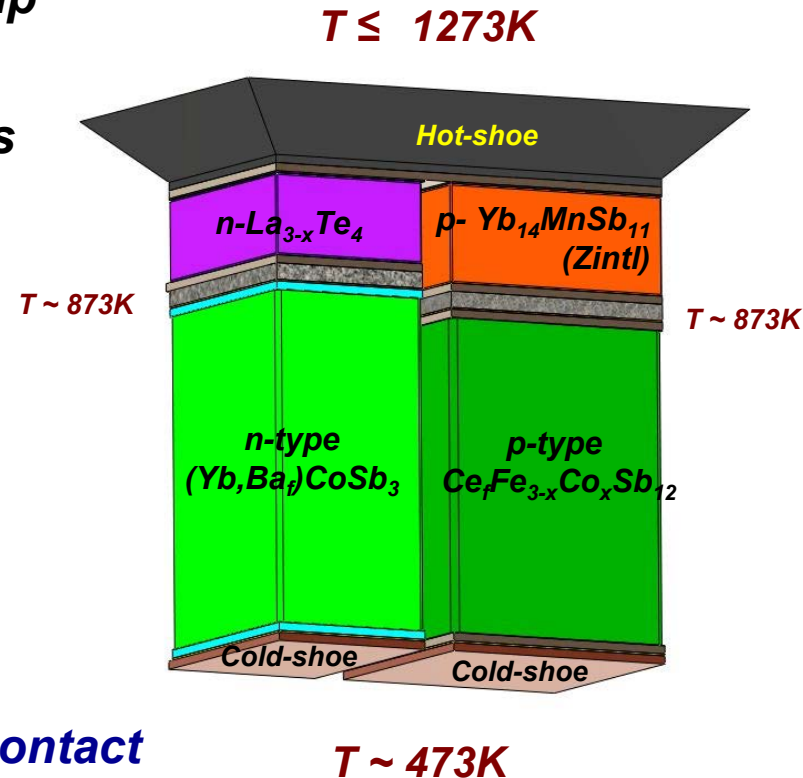
Leg segments

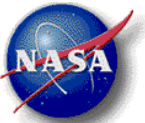
Machining
Stable metallization
Sublimation control

Couples

Design, Fabrication Assembly & Testing

Robust design
Stable, low electrical contact resistance interfaces
Couple Assembly
Thermal Insulation
Life demonstration



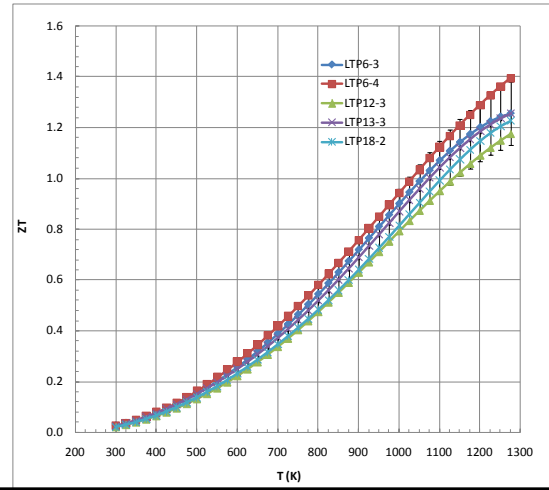


Segmented $\text{Yb}_{14}\text{MnSb}_{11}/\text{La}_{3-x}\text{Te}_4$



High Temperature TE Couple Technology Development

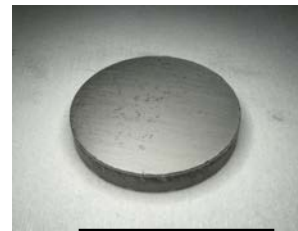
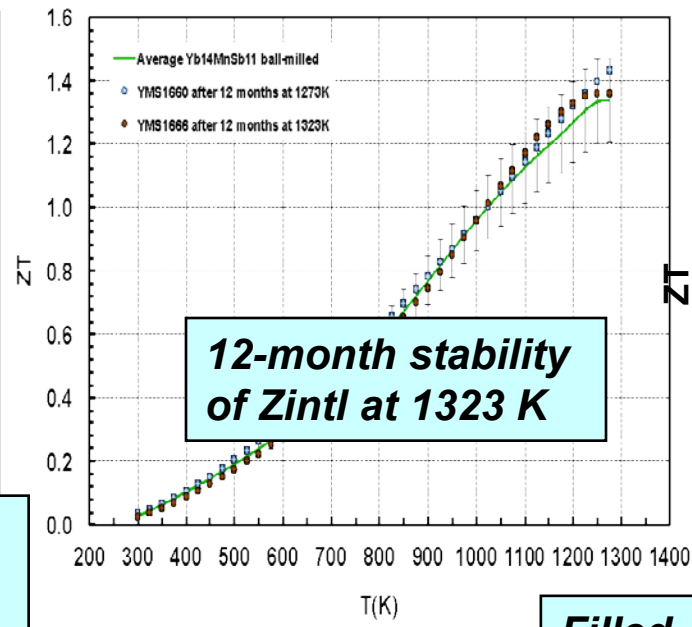
Powder Metallurgy Synthesis Scale-up and Reproducible TE properties



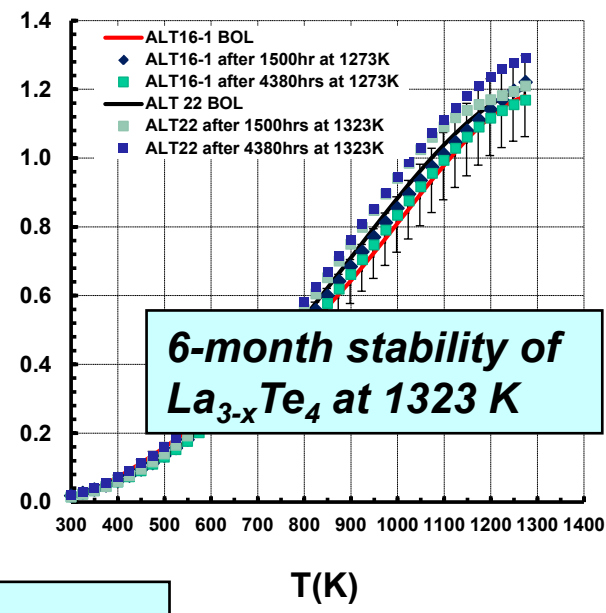
Reproducible BOL properties for $\text{Yb}_{14}\text{MnSb}_{11}$, $\text{La}_{3-x}\text{Te}_4$ and filled skutterudites produced in 100- to 200 g batches



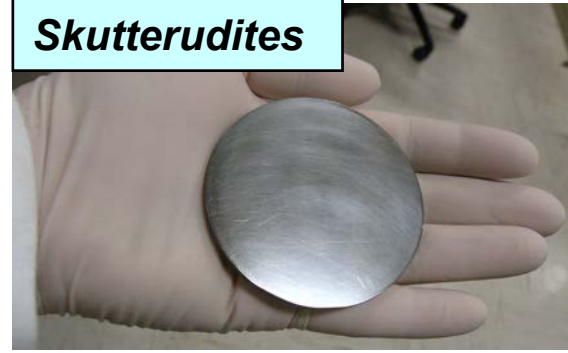
$\text{Yb}_{14}\text{MnSb}_{11}$

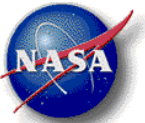


$\text{La}_{3-x}\text{Te}_4$



Filled Skutterudites



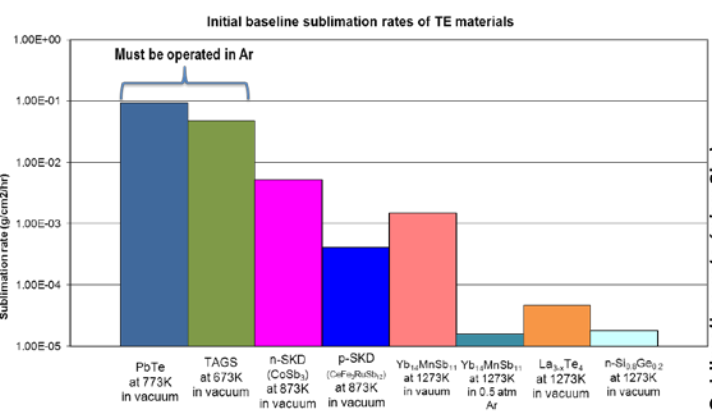


Segmented Yb₁₄MnSb₁₁/La_{3-x}Te₄

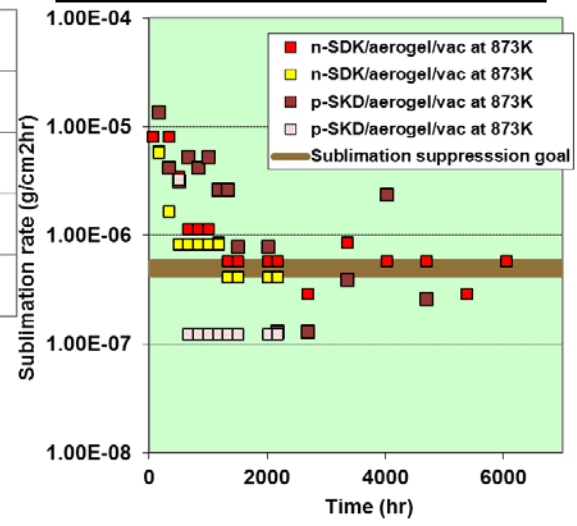


High Temperature TE Couple Technology Development

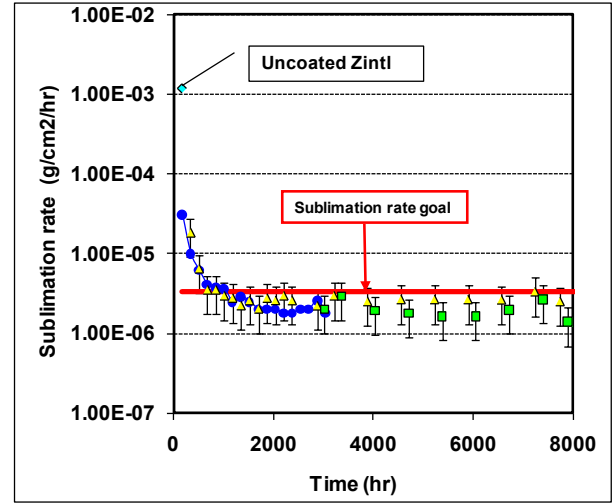
Sublimation Control for TE Materials and Thermally Stable Low Electrical Contact Resistance Metallizations



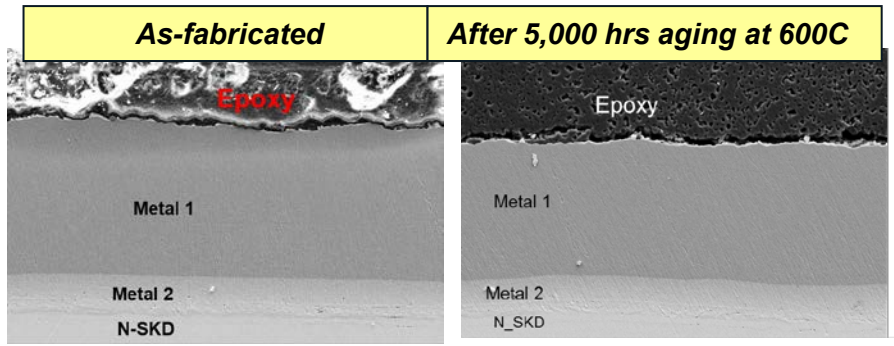
12-month stability of SKD Sublimation Control at 873 K



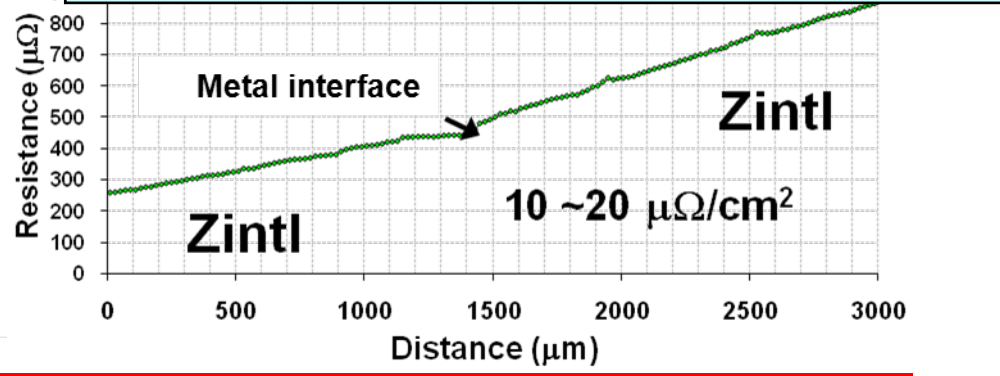
18-month stability of Zintl Sublimation Barrier Coating at 1273 K

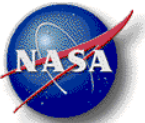


12-month stability of SKD Metallization at 873 K



2-month stability of Zintl Metallization at 1273 K

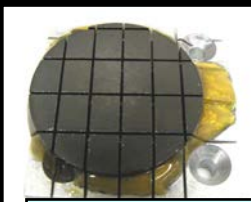





Segmented $\text{Yb}_{14}\text{MnSb}_{11}/\text{La}_{3-x}\text{Te}_4$ High Temperature TE Couple Technology Development




Metallized TE Segment Fabrication




Metallized Puck Dicing



$\text{La}_{3-x}\text{Te}_4$




$\text{Yb}_{14}\text{MnSb}_{11}$ Zintl



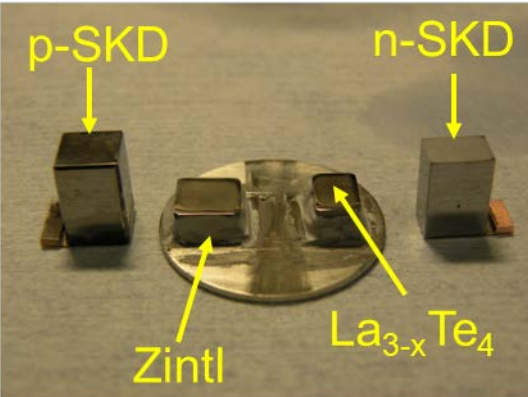
Filled Skutterudites

Couple Assembly and Test

Stand-alone Segmented Legs




Full couple assembly



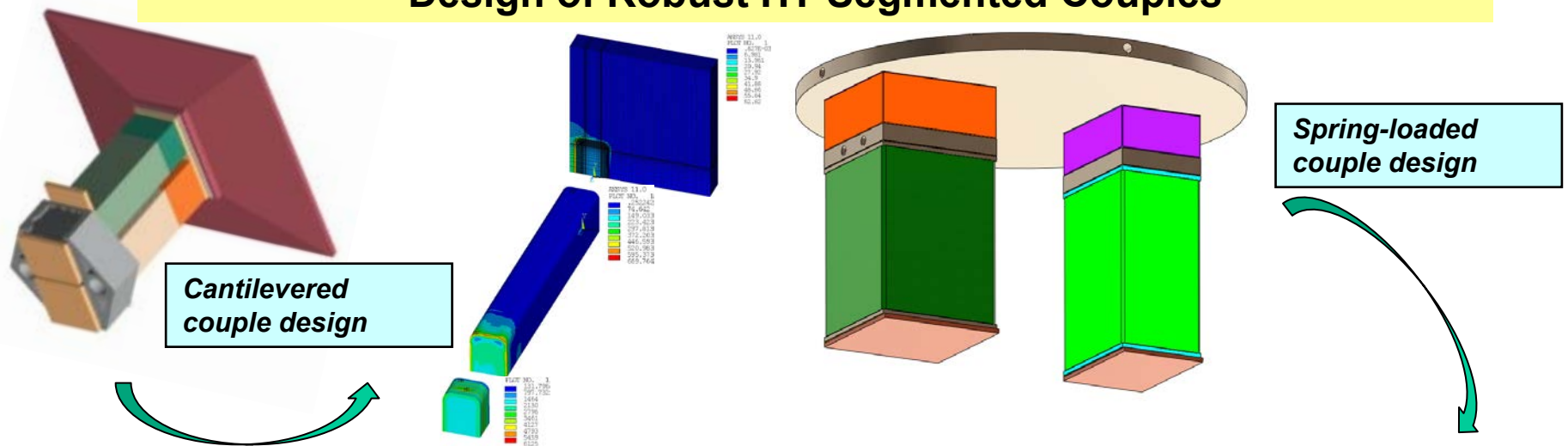
p-SKD
n-SKD
Zintl
 $\text{La}_{3-x}\text{Te}_4$

Sublimation Control and Thermal Insulation Packaging into Spring-loaded Test Fixture

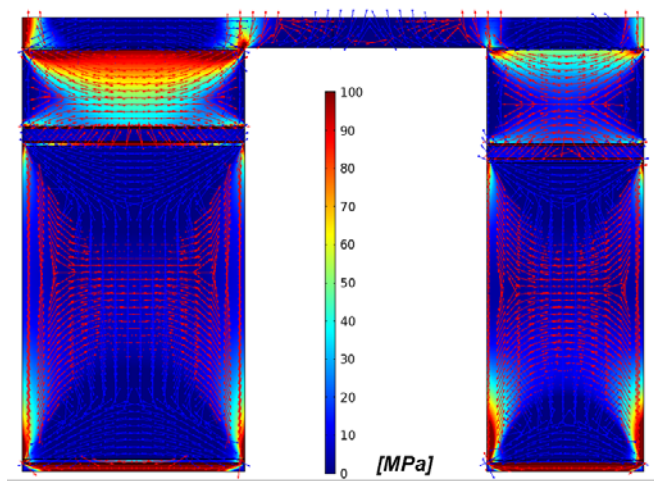


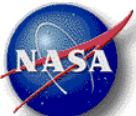
Hot Shoe

Design of Robust HT Segmented Couples



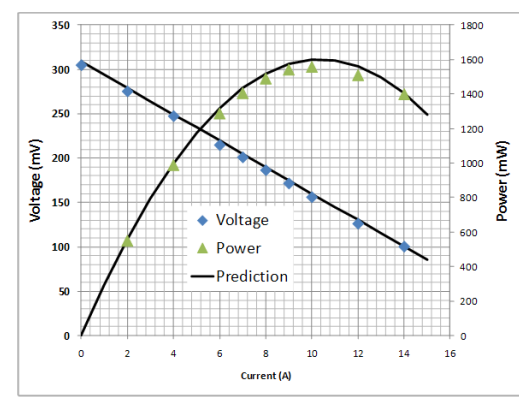
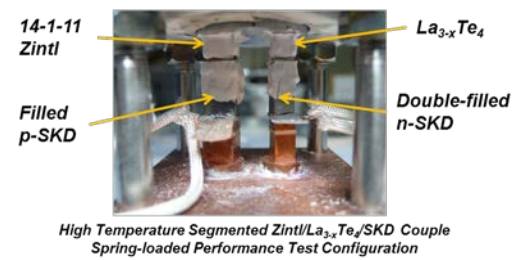
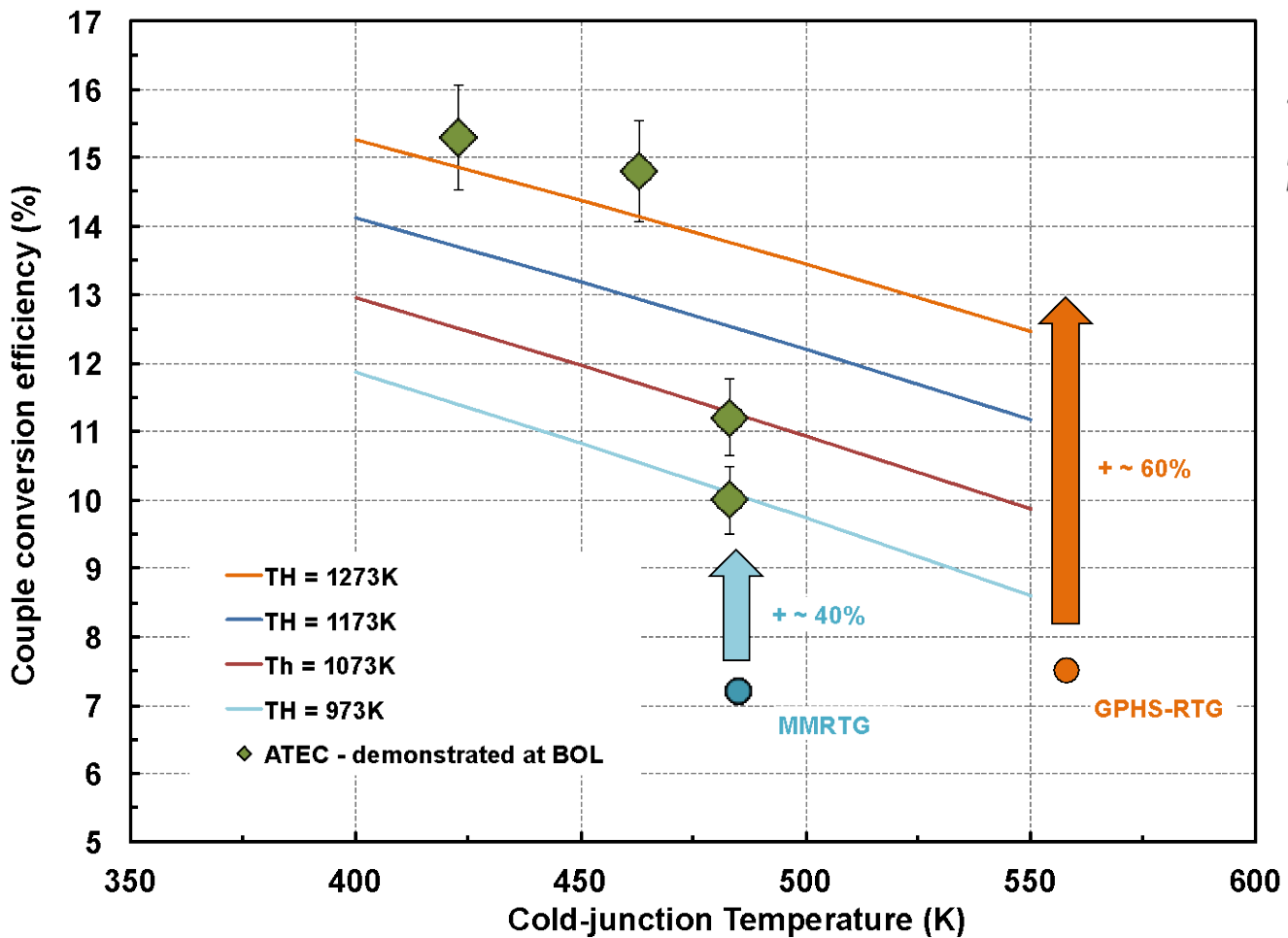
- Detailed Finite Element Analysis (ANSYS, COMSOL)
- Supported by experimental data on temperature dependent mechanical and thermal properties on TE materials, electrical and thermal interfaces
- Coupon-level demonstrations
- Couple-level validations
- Extensive life testing





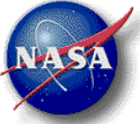
1st iteration for 1st Gen Segmented Couple testing

– Demonstrated BOL efficiency –



Beginning-of-Life (BOL)
Experimental vs. Predicted I-V and I-P curves
For Advanced TE Couple

• Demonstrated large increases in couple efficiency over MMRTG and GPHS couples. ~ 15% efficiency for 1273 -463 K operating temperature range

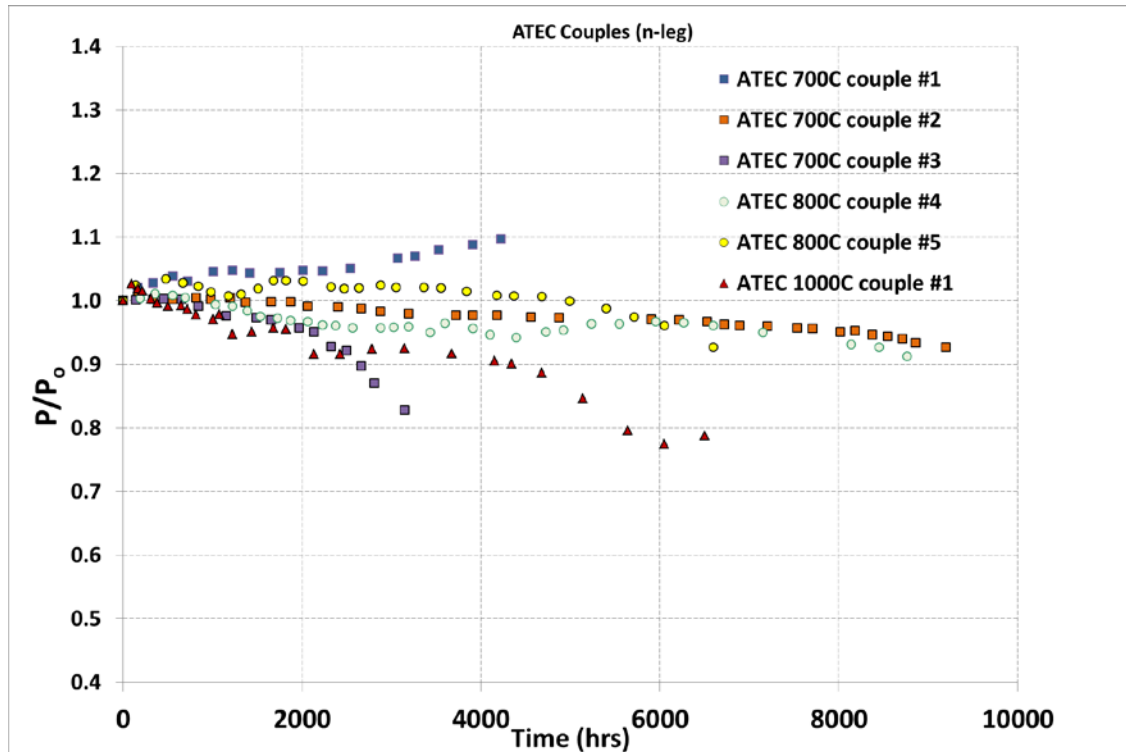


1st iteration for 1st Gen Segmented Couple testing

– Preliminary Life Assessment–



- Several couples have now been tested for up to 9,000 hours and at hot side operating temperatures ranging from 973 K up to 1273 K
- Long term performance degradation mechanisms have been identified; next iteration of couples will integrate small modifications to minimize degradation
 - Will be implemented later in FY12

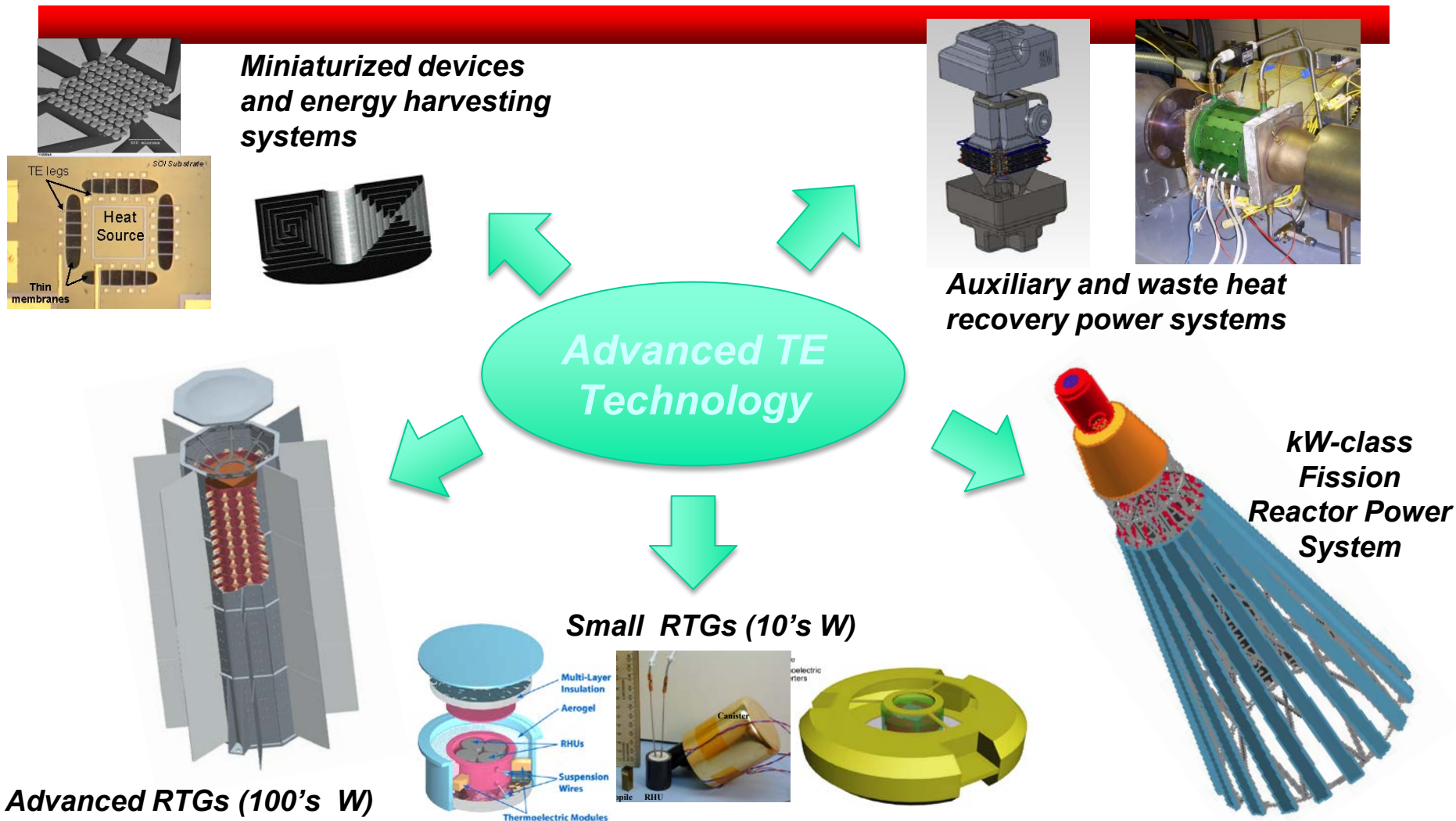


Changes in maximum Power output for n-leg of ATEC couples normalized to BOL performance



Potential for Terrestrial High Grade Waste Heat Recovery Applications

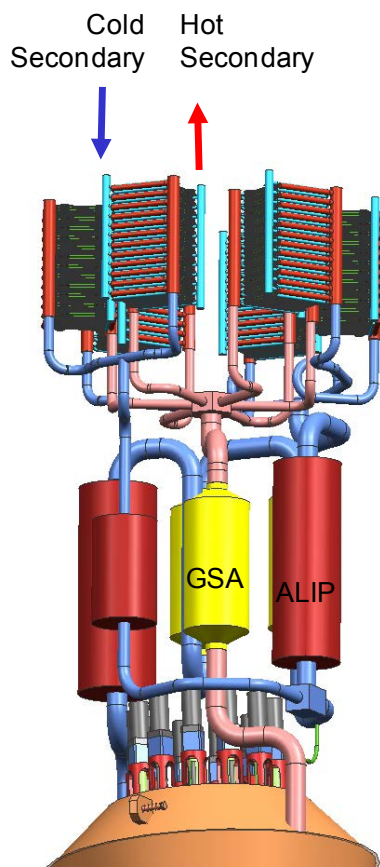
Advanced TE Power Systems



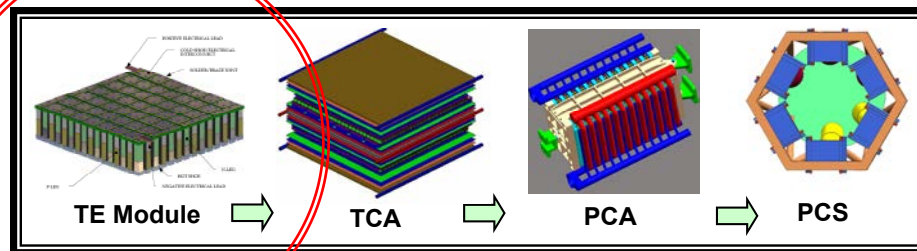
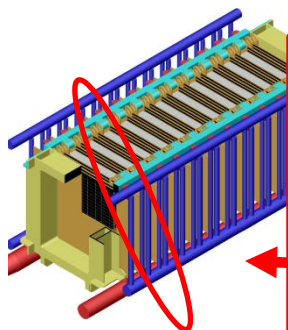
Advanced high temperature TE technology being developed for space power systems could also be applied to terrestrial Waste Heat Recovery and auxiliary power systems

Nuclear Electric Propulsion or Primary Power for Space Exploration and Science Missions

- Technology development was focused on arrays of thermoelectric couples grouped into power converter assemblies
- Used liquid metal heat exchangers to interface with reactor heat source and radiator heat sinks

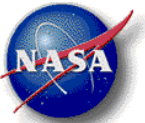


Power Converter Assembly



Development of robust high temperature thermoelectric module technology is critical to all applications

- **Using low cost, practical fabrication techniques and relatively inexpensive materials (including thermoelectrics)**
- **Ability to integrate with various heat exchangers**
- **Ability to reliably survive thermal/mechanical stresses**

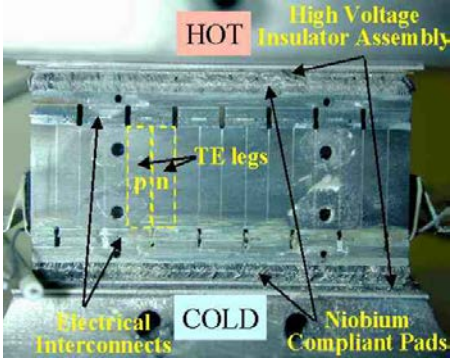


Mechanically Compliant High Temperature TE Module Technologies at NASA/DOE/JPL



SP-100 SiGe Multicouple (1990s)

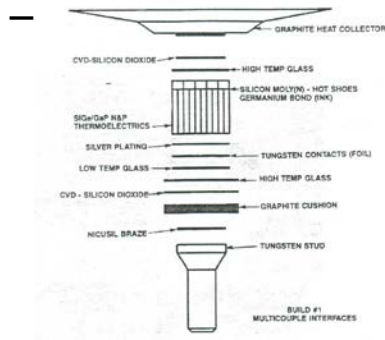
- Conductively coupled on hot side with built in compliant pads
- Tested for up to 25,000 hours



Designed for integration with flat plate HXs, 873 K - 1273 K Steady State Hot Side operation

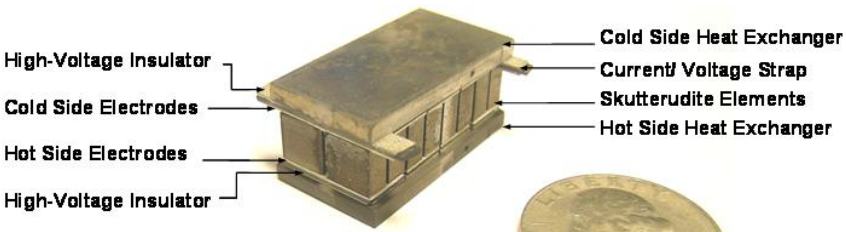
MOD-RTG SiGe Multicouple Technology (1980s)

- Graphite heat collector, bolted on radiator side



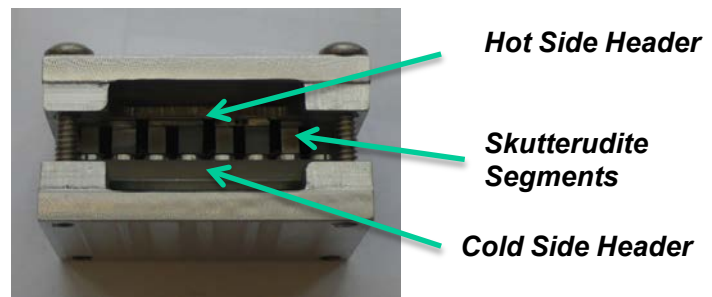
Designed for radiative coupling in RTG, 573 K - 1273 K Steady State operation

Skutterudite Module Developed at JPL under NASA/SMD In-Space Propulsion Program (2004-2005)

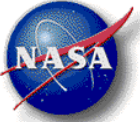


Designed for integration with flat plate HXs, 473 K - 873 K Steady State operation

Segmented Module under development for portable power system (2011-2012)



Designed for integration with high efficiency HXs, 400 K - 1223 K operation with multiple thermal cycles in vacuum or atmospheric environments



Summary



- **Successfully completed the development of first generation Advanced High Temperature TE materials**
 - Developed first generation TE materials with $\times 2$ ZT_{ave} improvement
 - Transitioned several first generation TE materials for engineering development of couples
- **The majority of risks at the first generation TE materials and components levels have been retired**
 - Demonstrated long term stability of first generation TE materials
 - Components-level life demonstrated through extended tests (up to 11,600 hours)
- **Demonstrated up to 15% BOL efficiency with segmented TE couples**
 - Work is in progress to demonstrate life performance capabilities
 - Without life, high ZT does not matter!
 - Fabricated and conducted up to 9,000 hrs of life assessment for 1st iteration ATEC couples
 - Still some work to be done to retire most significant degradation mechanisms but there are no “show stoppers” so far
- **New technology could be applied to selected high temperature waste heat recovery applications**
 - Availability of rugged TE couple & modular devices is a must to enable new applications



Acknowledgments



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 - Ole Miss, University of Southern California
 - Michigan State University
 - ATA Engineering
 - Teledyne Energy Systems
 - HS Rocketdyne